PROCEEDINGS OF SPIE

Next-Generation Robots and Systems

Dan O. Popa Muthu B. J. Wijesundara Editors

8 May 2014 Baltimore, Maryland, United States

Sponsored and Published by SPIE

Volume 9116

Proceedings of SPIE 0277-786X, V. 9116

SPIE is an international society advancing an interdisciplinary approach to the science and application of light.

Next-Generation Robots and Systems, edited by Dan O. Popa, Muthu B. J. Wijesundara, Proc. of SPIE Vol. 9116, 911601 · © 2014 SPIE · CCC code: 0277-786X/14/\$18 · doi: 10.1117/12.2072970

Proc. of SPIE Vol. 9116 911601-1

The papers included in this volume were part of the technical conference cited on the cover and title page. Papers were selected and subject to review by the editors and conference program committee. Some conference presentations may not be available for publication. The papers published in these proceedings reflect the work and thoughts of the authors and are published herein as submitted. The publisher is not responsible for the validity of the information or for any outcomes resulting from reliance thereon.

Please use the following format to cite material from this book:

Author(s), "Title of Paper," in Next-Generation Robots and Systems, edited by Dan O. Popa, Muthu B. J. Wijesundara, Proceedings of SPIE Vol. 9116 (SPIE, Bellingham, WA, 2014) Article CID Number.

ISSN: 0277-786X ISBN: 9781628410532

Published by **SPIE** P.O. Box 10, Bellingham, Washington 98227-0010 USA Telephone +1 360 676 3290 (Pacific Time) · Fax +1 360 647 1445 SPIE.org

Copyright © 2014, Society of Photo-Optical Instrumentation Engineers.

Copying of material in this book for internal or personal use, or for the internal or personal use of specific clients, beyond the fair use provisions granted by the U.S. Copyright Law is authorized by SPIE subject to payment of copying fees. The Transactional Reporting Service base fee for this volume is \$18.00 per article (or portion thereof), which should be paid directly to the Copyright Clearance Center (CCC), 222 Rosewood Drive, Danvers, MA 01923. Payment may also be made electronically through CCC Online at copyright.com. Other copying for republication, resale, advertising or promotion, or any form of systematic or multiple reproduction of any material in this book is prohibited except with permission in writing from the publisher. The CCC fee code is 0277-786X/14/\$18.00.

Printed in the United States of America.

Publication of record for individual papers is online in the SPIE Digital Library.



Paper Numbering: Proceedings of SPIE follow an e-First publication model, with papers published first online and then in print and on CD-ROM. Papers are published as they are submitted and meet publication criteria. A unique, consistent, permanent citation identifier (CID) number is assigned to each article at the time of the first publication. Utilization of CIDs allows articles to be fully citable as soon as they are published online, and connects the same identifier to all online, print, and electronic versions of the publication. SPIE uses a six-digit CID article numbering system in which:

- The first four digits correspond to the SPIE volume number.
- The last two digits indicate publication order within the volume using a Base 36 numbering
- system employing both numerals and letters. These two-number sets start with 00, 01, 02, 03, 04, 05, 06, 07, 08, 09, 0A, 0B ... 0Z, followed by 10-1Z, 20-2Z, etc.

The CID Number appears on each page of the manuscript. The complete citation is used on the first page, and an abbreviated version on subsequent pages. Numbers in the index correspond to the last two digits of the six-digit CID Number.

Contents

- v Conference Committee
- vii Introduction

SESSION 1 SENSORS FOR NEXT-GENERATION ROBOTICS I

- 9116 02 A haptic sensing upgrade for the current EOD robotic fleet (Invited Paper) [9116-1] P. Rowe, RE², Inc. (United States)
- 9116 03 Tactile MEMS-based sensor for delicate microsurgery [9116-2]
 Y. S. Park, Argonne National Lab. (United States); W. Lee, The Univ. of Texas at Arlington (United States); N. Gopalsami, Argonne National Lab. (United States); M. Gundeti, The Univ. of Chicago Medical Ctr. (United States)
- 9116 04 **Tactile sensing and compliance in MicroStressBot assemblies** [9116-3] R. Majumdar, V. Foroutan, I. Paprotny, Univ. of Illinois at Chicago (United States)
- 9116 05 Haptic exploration of fingertip-sized geometric features using a multimodal tactile sensor [9116-4]
 R. D. Ponce Wong, R. B. Hellman, V. J. Santos, Arizona State Univ. (United States)

SESSION 2 SENSORS FOR NEXT-GENERATION ROBOTICS II

- 9116 06 **Experimental testbed for robot skin characterization and interaction control** [9116-5] K. R. Shook, A. Habib, W. H. Lee, D. O. Popa, The Univ. of Texas at Arlington (United States)
- 9116 07 **Conformal grasping using feedback controlled bubble actuator array** [9116-6] W. Carrigan, R. Stein, M. Mittal, M. B. J. Wijesundara, The Univ. of Texas at Arlington Research Institute (United States)
- 9116 08 Development and characterization of a new silicone/platine based 2-DoF sensorized end-effector for micromanipulators [9116-7]
 X. Xu, J. Agnus, M. Rakotondrabe, FEMTO-ST Institute, CNRS, Univ. de Franche-Comté (France)
- 9116 09 A multidirectional capacitive proximity sensor array [9116-8]
 J. Long, Mitsubishi Electric Research Labs. (United States) and Univ. of California, San Diego (United States); B. Wang, Mitsubishi Electric Research Labs. (United States)

SESSION 3 SENSORS FOR NEXT-GENERATION ROBOTICS III

9116 0A **Needs and emerging trends of remote sensing** [9116-9] M. McNair, The Univ. of Texas at Arlington (United States)

- 9116 0B **Toward controlling perturbations in robotic sensor networks** [9116-10] A. G. Banerjee, S. R. Majumder, General Electric Global Research (United States)
- 9116 OC
 Advanced THz sensor array for precise position and material properties recognition
 [9116-11]
 A. Sešek, J. Trontelj, Univ. of Ljubljana (Slovenia); A. Švigelj, Letrika Lab. d.o.o (Slovenia)
- 9116 0D Sensor selection for outdoor air quality monitoring [9116-12]
 - K. L. Dorsey, J. R. Herr, Univ. of California, Berkeley (United States); A. P. Pisano, Univ. of California, San Diego (United States)

SESSION 4 SENSORS FOR NEXT-GENERATION ROBOTICS IV

- 9116 OF **EHD as sensor fabrication technology for robotic skins** [9116-14] J. Shin, W. H. Lee, C. P. Nothnagle, M. B. J. Wijesundara, The Univ. of Texas at Arlington Research Institute (United States)
- 9116 0H Grip pressure measurements during activities of daily life [9116-20] J. Sanford, The Univ. of Texas at Arlington (United States); C. Young, Univ. of North Texas Health Science Ctr. at Fort Worth (United States); D. Popa, The Univ. of Texas at Arlington (United States); N. Bugnariu, R. Patterson, Univ. of North Texas Health Science Ctr. at Fort Worth (United States)

Author Index

Conference Committee

Symposium Chair

David A. Whelan, Boeing Defense, Space, and Security (United States)

Symposium Co-chair

Wolfgang Schade, Technische Universität Clausthal (Germany) and Fraunhofer Heinrich-Hertz-Institut (Germany)

Conference Chairs

 Dan O. Popa, The University of Texas at Arlington (United States)
 Muthu B. J. Wijesundara, The University of Texas at Arlington Research Institute (United States)

Conference Program Committee

Rakesh Murthy, Jet Propulsion Laboratory (United States) Andrew J. Tickle, Coventry University (United Kingdom)

Introduction

2014 saw the debut of a new emerging technologies conference dedicated to Sensors for Next Generation Robotics. We envisioned our conference as a meeting forum for engineers and scientists, from academia, industry, and national labs, focusing on emerging sensors and their applications for robotics. Since every robot is equipped with sensors, we hope to bring to the forefront unique challenges of sensor fabrication, integration, information processing, control, and usability for robotics.

Due to the proliferation of mass-produced, miniaturized sensors, it is now possible to envision massively distributed sensors being used to enhance perception, cognition, and control capabilities of next generation robots. In fact, applications where new, more intelligent robots are needed cut across all dimensional scales and industrial sectors. Examples include assisted living environments, search and rescue in disaster areas, neural surgery and prosthetics, nanomanufacturing, selfdriving vehicles, human-friendly industrial assembly and smart material handling, and so on. One exciting next generation application is endowing humanoid robots with perception comparable with those of humans, including distributed touch through robotic skin, hearing, and vision, but also super-human perception, such as the ability to see in the dark. Using off-the-shelf sensors that have not been designed specifically for robotics is fraught with additional challenges that must be mitigated by consideration of power, weight, and interconnection to the robot early on in the design process.

This conference focuses on new sensors and sensor arrays for robotics and autonomous vehicles, new form factors, and packaging schemes to help integrate robots and sensors, new applications of robots enabled by increased perception capabilities, and challenges in sensor fusion, networking, and control brought about by massive amounts of sensor data available to the robot. Technical scientific papers related to robot sensors that push beyond the state-ofthe-art in industry are solicited. New robotics applications reflecting the state of art in industry, including those with dual uses (military-defense and commercialindustrial) are also welcome.

In 2014, the conference had 14 submitted papers and 15 presentations organized in 4 sessions, including: 1) Haptics and Tactile Sensing, 2) Sensor Arrays and Interaction Control, 3) Remote Sensing and Sensor Networks, and 4) Sensor Fabrication and Evaluation. We envision that the number of papers and attendance at our conference will increase in future years, as robots become more ubiquitous in our daily lives. We look forward to your participation in 2015!

> Dan O. Popa Muthu B. J. Wijesundara